



## Material Content Data Sheet



<b>Sales Product Name</b>		BTS5215L		<b>Issued</b>		1. August 2018			
<b>MA#</b>		MA002262398							
<b>Package</b>		PG-DSO-12-9		<b>Weight*</b>		367.43 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	4.733	1.29	1.29	12882	12882	
leadframe	inorganic material	phosphorus	7723-14-0	0.061	0.02		167		
	non noble metal	iron	7439-89-6	0.204	0.06		555		
	non noble metal	copper	7440-50-8	203.829	55.47	55.55	554747	555469	
	non noble metal	aluminium	7429-90-5	0.715	0.19	0.19	1946	1946	
wire	non noble metal	aluminium	7429-90-5	0.715	0.19	0.19	1946	1946	
encapsulation	organic material	carbon black	1333-86-4	0.300	0.08		817		
	plastics	epoxy resin	-	21.466	5.84		58422		
	inorganic material	silicondioxide	60676-86-0	128.345	34.93	40.85	349308	408547	
leadfinish	non noble metal	tin	7440-31-5	3.310	0.90	0.90	9008	9008	
plating	inorganic material	phosphorus	7723-14-0	0.001	0.00		4		
	non noble metal	nickel	7440-02-0	0.617	0.17	0.17	1680	1684	
solder	non noble metal	tin	7440-31-5	0.077	0.02		209		
	noble metal	silver	7440-22-4	0.096	0.03		262		
	non noble metal	lead	7439-92-1	3.672	1.00	1.05	9993	10464	
*deviation	< 10%					Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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